Silicon P-Channel MOS FET

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Application

Low frequency power amplifier

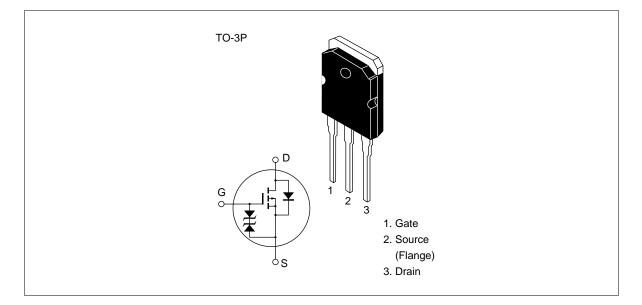
Complementary pair with 2SK1056, 2SK1057 and 2SK1058

Features

- Good frequency characteristic
- High speed switching
- Wide area of safe operation
- Enhancement-mode
- Good complementary characteristics
- Equipped with gate protection diodes
- Suitable for audio power amplifier



Outline



Absolute Maximum Ratings (Ta = 25°C)

	Symbol	Ratings	Unit
2SJ160	V _{DSX}	-120	V
2SJ161		-140	
2SJ162		-160	
	V _{GSS}	±15	V
	I _D	I _D –7	
Body to drain diode reverse drain current		-7	А
	Pch*1	100	W
Channel temperature		150	°C
	Tstg	-55 to +150	°C
	2SJ161 2SJ162	$ \frac{2SJ160}{2SJ161} V_{DSX} $ $ \frac{2SJ161}{2SJ162} V_{GSS} $ $ I_D $ e drain current $ I_{DR} $ $ Pch^{*1} $ $ Tch $	$\begin{array}{c c} 2SJ160 & V_{DSX} & -120 \\ \hline 2SJ161 & -140 \\ \hline 2SJ162 & -160 \\ \hline V_{GSS} & \pm 15 \\ \hline I_D & -7 \\ \hline e \ drain \ current & I_{DR} & -7 \\ \hline Pch^{*1} & 100 \\ \hline Tch & 150 \\ \end{array}$

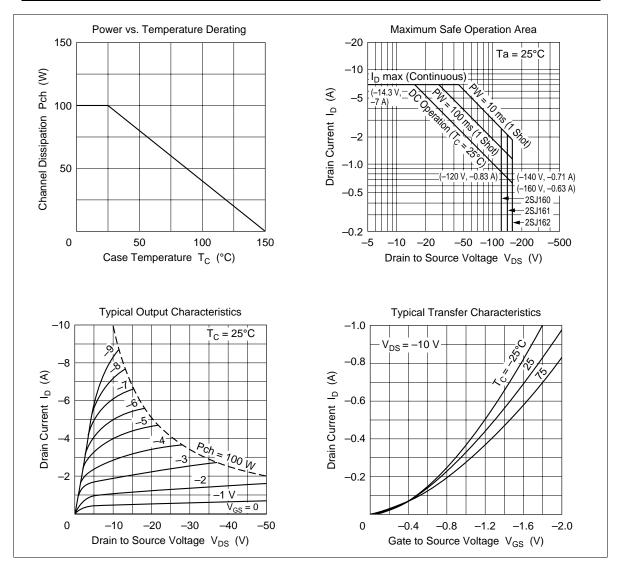
Note: 1. Value at $T_c = 25^{\circ}C$

Electrical Characteristics (Ta = 25°C)

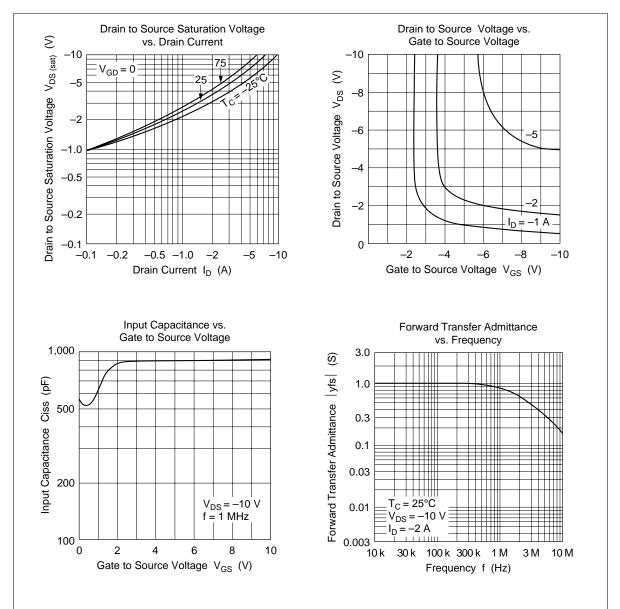
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SJ160	V _{(BR)DSX}	-120	_	_	V	$I_{\rm D}$ = -10 mA , $V_{\rm GS}$ = 10 V
breakdown voltage	2SJ161		-140		_	V	
	2SJ162		-160	_	_	V	
Gate to source break voltage	kdown	$V_{(\text{BR})\text{GSS}}$	±15	—	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source cutof	f voltage	$V_{GS(off)}$	-0.15	_	-1.45	V	$I_{\rm D} = -100 \text{ mA}, V_{\rm DS} = -10 \text{ V}$
Drain to source satu voltage	ration	$V_{\text{DS(sat)}}$	—	—	-12	V	$I_{\rm D} = -7$ A, $V_{\rm GD} = 0^{*1}$
Forward transfer adr	nittance	y _{fs}	0.7	1.0	1.4	S	$I_{\rm D} = -3$ A, $V_{\rm DS} = -10$ V ^{*1}
Input capacitance		Ciss	_	900		pF	$V_{GS} = 5 V, V_{DS} = -10V,$
Output capacitance		Coss	_	400		pF	f = 1 MHz
Reverse transfer cap	bacitance	Crss	_	40	_	pF	
Turn-on time		t _{on}	_	230		ns	$V_{DD} = -20 \text{ V}, \text{ I}_{D} = -4 \text{ A}$
Turn-off time		t _{off}	_	110	_	ns	

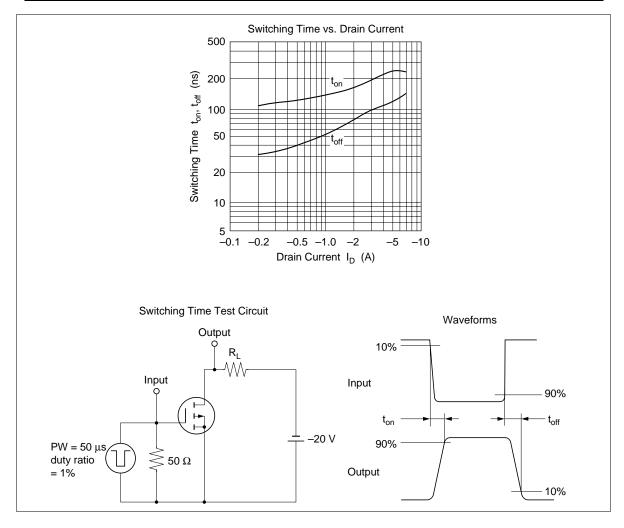
Note: 1. Pulse test

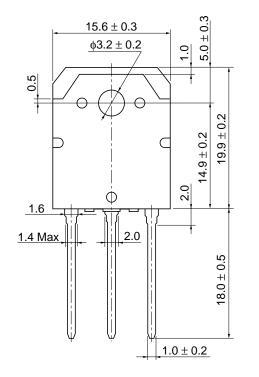
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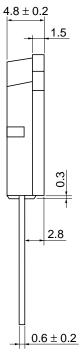






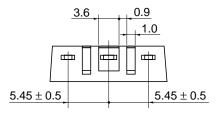








Unit: mm



Hitachi Code	TO-3P
JEDEC	—
EIAJ	Conforms
Weight (reference value)	5.0 g

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